


















Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.005mm	3.5
4		Top Layer	Copper	0.042mm	
5		Dielectric 1	FR-4 (tg > 150C)	0.220mm	4.2
6		Mid-Layer 1	Copper	0.035mm	
7		Dielectric 2	FR-4 (tg > 150C)	0.350mm	4.2
8		Mid-Layer 2	Copper	0.035mm	
9		Dielectric 3	FR-4 (tg > 150C)	0.220mm	4.2
10		Mid-Layer 3	Copper	0.035mm	
11		Dielectric 4	FR-4 (tg > 150C)	0.350mm	4.2
12		Mid-Layer 4	Copper	0.035mm	
13		Dielectric 5	FR-4 (tg > 150C)	0.220mm	4.2
14		Bottom Layer	Copper	0.042mm	
15		Bottom Solder	Solder Resist	0.005mm	3.5
16		Bottom Overlay			
17		Bottom Paste			
	Height : 1.594mm				